600V N-Channel MOSFET

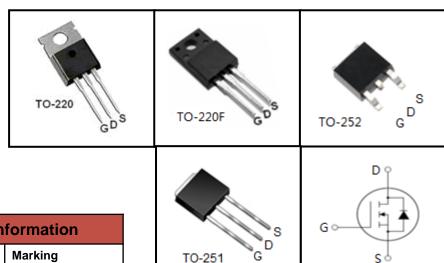
FEATURES

- Fast switching
- 100% avalanche tested
- Improved dv/dt capability

APPLICATIONS

- Switch Mode Power Supply (SMPS)
- Uninterruptible Power Supply (UPS)
- Power Factor Correction (PFC)

Device Marking and Package Information					
Device	Package	Marking			
CS8N60F	TO-220F	CS8N60F			
CS8N60P	TO-220	CS8N60P			
CS8N60U	TO-251	CS8N60U			
CS8N60D	TO-252	CS8N60D			
CS8N60F-B	TO-220F-B	CS8N60F-B			



Absolute Maximum Ratings $T_C = 25^{\circ}C$, unless otherwise noted						
Parameter	Symbol		Unit			
raiametei	Symbol	TO-220F	TO-220	TO-251	TO-252	Unit
Drain-Source Voltage (V _{GS} = 0V)	V _{DSS}	600			٧	
Continuous Drain Current	I _D	8		Α		
Pulsed Drain Current (note1)	I _{DM}	32			А	
Gate-Source Voltage	V _{GSS}	±30		V		
Single Pulse Avalanche Energy (note2)	E _{AS}	217.8			mJ	
Avalanche Current (note1)	I _{AR}	6.6			А	
Repetitive Avalanche Energy (note1)	E _{AR}	130.6			mJ	
Power Dissipation (T _C = 25°C)	P_{D}	65 106		W		
Operating Junction and Storage Temperature Range	T _J , T _{stg}	-55~+150				°C

Thermal Resistance						
Barrandar	Symbol	Value				11.24
Parameter		TO-220F	TO-220	TO-251	TO-252	Unit
Thermal Resistance, Junction-to-Case	R _{thJC}	1.95		1.17		00.00
Thermal Resistance, Junction-to-Ambient	R _{thJA}	62.5	60		°C/W	



CS8N60F,CS8N60P, CS8N60U,CS8N60D,CS8N65F-B

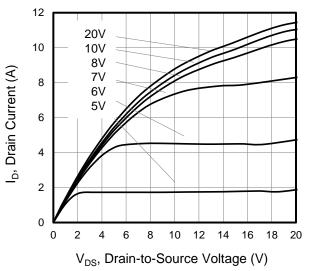
Specifications T _J = 25°C, unless otherwise noted									
Parameter	Symbol	Test Conditions	Value			Unit			
r al allietei	Syllibol	rest conditions	Min.	Тур.	Max.	Unit			
Static									
Drain-Source Breakdown Voltage	$V_{(BR)DSS}$	$V_{GS} = 0V, I_D = 250\mu A$	600			V			
Zero Gate Voltage Drain Current	I _{DSS}	$V_{DS} = 600V, V_{GS} = 0V, T_{J} = 25^{\circ}C$	-	-	1	μΑ			
Gate-Source Leakage	I _{GSS}	$V_{GS} = \pm 30V$			±100	nA			
Gate-Source Threshold Voltage	$V_{GS(th)}$	$V_{DS} = V_{GS}, I_{D} = 250 \mu A$	3.0		4.0	V			
Drain-Source On-Resistance (Note3)	R _{DS(on)}	$V_{GS} = 10V, I_{D} = 4A$		0.85	1	Ω			
Dynamic									
Input Capacitance	C _{iss}	$V_{GS} = 0V$, $V_{DS} = 25V$, $f = 1.0MHz$		966		pF			
Output Capacitance	C _{oss}			115.5					
Reverse Transfer Capacitance	C _{rss}			19.5					
Total Gate Charge	Q_g	$V_{DD} = 480V, I_{D} = 8A,$ $V_{GS} = 10V$		35		nC			
Gate-Source Charge	Q_{gs}			4.5					
Gate-Drain Charge	Q_{gd}			18.5					
Turn-on Delay Time	t _{d(on)}			38.5		ns			
Turn-on Rise Time	t _r	$V_{DD} = 300V, I_{D} = 8A,$		28.5					
Turn-off Delay Time	t _{d(off)}	$R_G = 25 \Omega$		153					
Turn-off Fall Time	t _f			43.6					
Drain-Source Body Diode Character	istics								
Continuous Body Diode Current	Is				8	- A			
Pulsed Diode Forward Current	I _{SM}	T _C = 25 °C			32				
Body Diode Voltage	V _{SD}	$T_J = 25^{\circ}\text{C}, I_{SD} = 4\text{A}, V_{GS} = 0\text{V}$			1.4	V			
Reverse Recovery Time	t _{rr}	$V_{GS} = 0V, I_{S} = 8A,$		575.6		ns			
Reverse Recovery Charge	Q _{rr}	di _F /dt =100A /μs		1.96		μC			

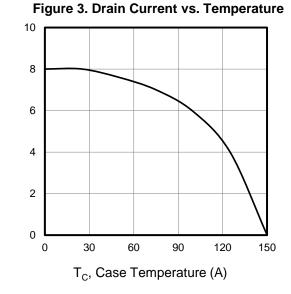
Notes

- 1. Repetitive Rating: Pulse width limited by maximum junction temperature
- 2. L=10mH, V_{DD} = 50V, R_G = 25 Ω , Starting T_J = 25 $^{\circ}C$
- 3. Pulse Test: Pulse width ≤ 300µs, Duty Cycle ≤ 1%

Typical Characteristics $T_J = 25^{\circ}C$, unless otherwise noted

Figure 1. Output Characteristics ($T_J = 25^{\circ}C$)





Drain Current (A)

Figure 5. Transfer Characteristics

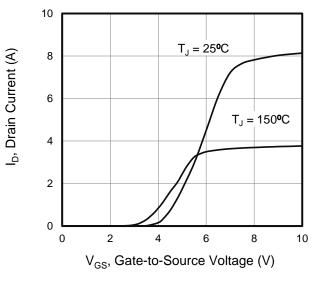


Figure 2. Body Diode Forward Voltage

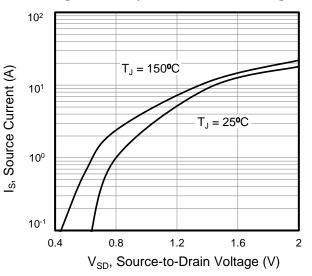


Figure 4. BV_{DSS} Variation vs. Temperature

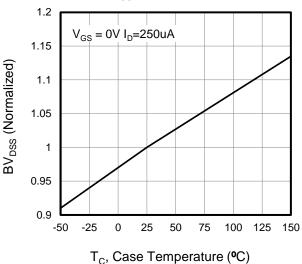
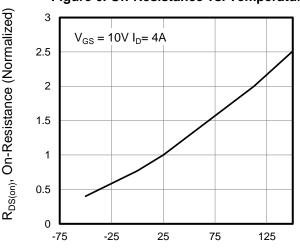


Figure 6. On-Resistance vs. Temperature



Typical Characteristics $T_J = 25^{\circ}\text{C}$, unless otherwise noted

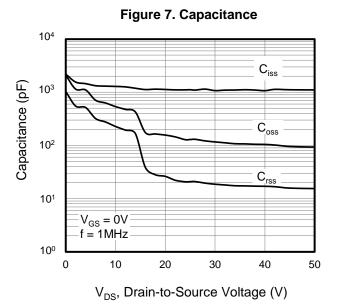


Figure 9. Transient Thermal Impedance TO-251,TO-252,TO-220

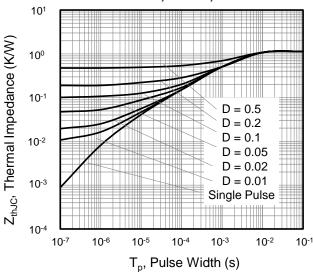


Figure 8. Gate Charge

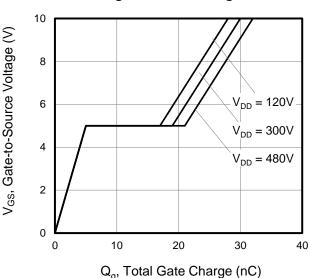


Figure 10. Transient Thermal Impedance

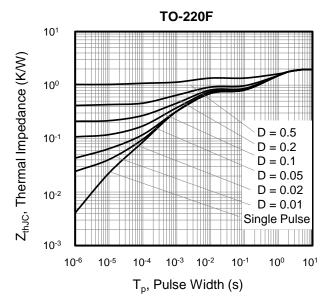


Figure A: Gate Charge Test Circuit and Waveform

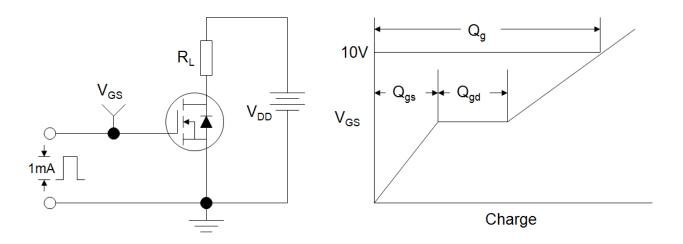


Figure B: Resistive Switching Test Circuit and Waveform

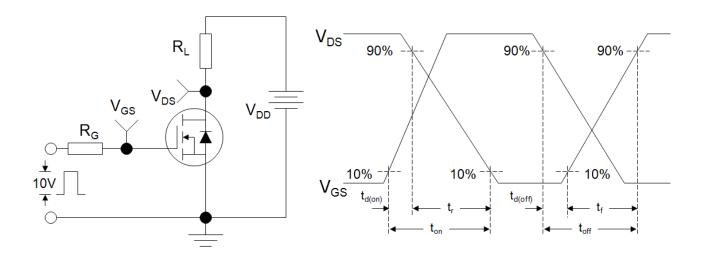
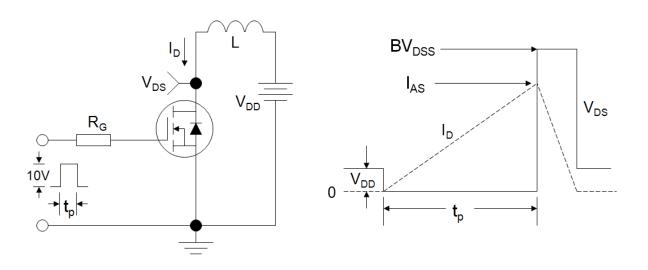
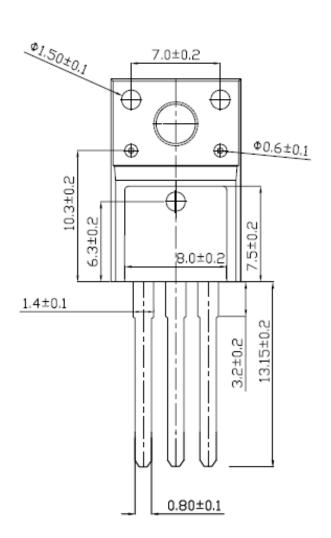


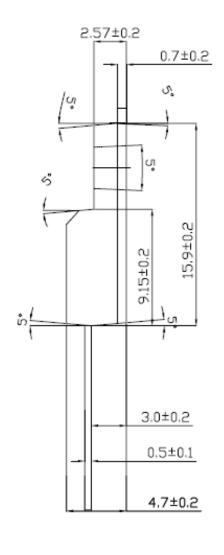
Figure C: Unclamped Inductive Switching Test Circuit and Waveform





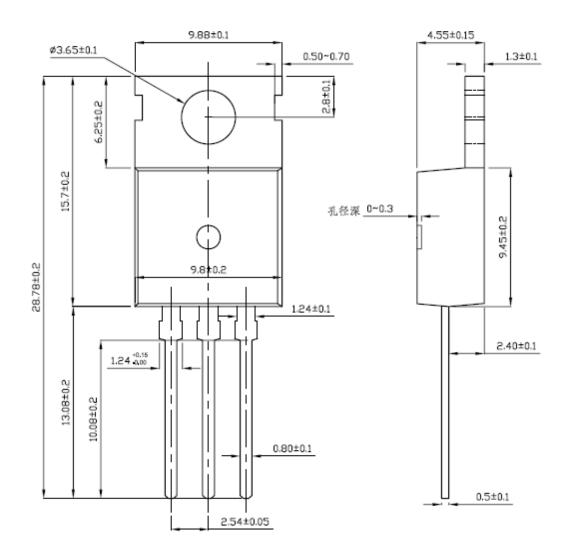
TO-220F





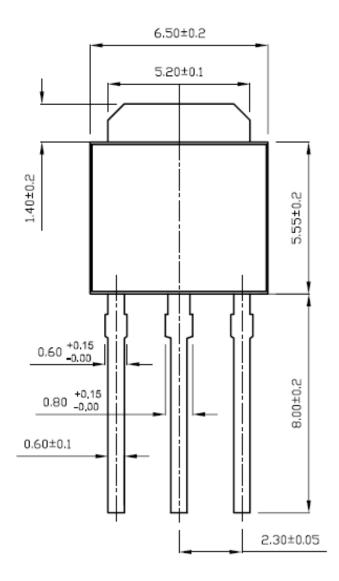


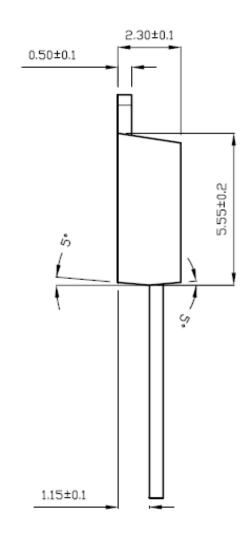
TO-220





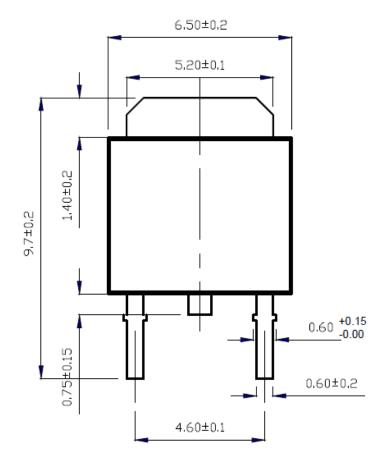
TO-251

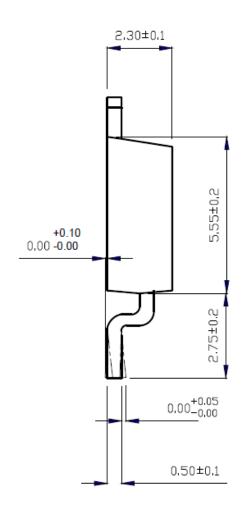






TO-252







CS8N60F,CS8N60P, CS8N60U,CS8N60D,CS8N65F-B

Disclaimer

All product specifications and data are subject to change without notice.

For documents and material available from this datasheet, Suzhou Convert does not warrant or assume any legal liability or responsibility for the accuracy, completeness of any product or technology disclosed hereunder.

No license, express or implied, by estoppels or otherwise, to any intellectual property rights is granted by this document or by any conduct of Suzhou Convert.

The products shown herein are not designed for use in medical, life-saving, or life-sustaining applications unless. Customers using or selling Suzhou Convert products not expressly indicated for use in such applications do so entirely at their own risk and agree to fully indemnify Suzhou Convert for any damages arising or resulting from such use or sale.

Suzhou Convert disclaims any and all liability arising out of the use or application of any product described herein or of any information provided herein to the maximum extent permitted by law. The product specifications do not expand or otherwise modify Suzhou Convert's terms and conditions of purchase, including but not limited to the warranty expressed therein, which apply to these products.

Suzhou Convert SemiConductor CO., Ltd. strives to supply high-quality high-reliability products. However, any and all semiconductor products fail with some probability. It is possible that these probabilistic failures could give rise to accidents or events that could endanger human lives that could give rise to smoke or fire, or that could cause damage to other property. When designing equipment, adopt safety measures so that these kinds of accidents or events cannot occur. Such measures include but are not limited to protective circuits and error prevention circuits for safe design, redundant design, and structural design.

In the event that any or all Suzhou Convert products (including technical data, services) described or contained herein are controlled under any of applicable local export control laws and regulations, such products must not be exported without obtaining the export license from the authorities concerned in accordance with the above law.

Information (including circuit diagrams and circuit parameters) herein is for example only; it is not guaranteed for volume production. Suzhou Convert believes information herein is accurate and reliable, but no guarantees are made or implied regarding its use or any infringements of intellectual property rights or other rights of third parties.